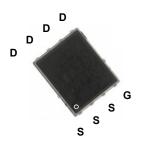


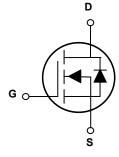


Main Product Characteristics

BV _{DSS}	80V		
R _{DS(ON)}	7mΩ		
I _D	75A		



PPAK5x6



Schematic Diagram

Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



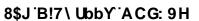
Description

The GSFP0876 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

Absolute Maximum Ratings (T_C=25°C unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	V _{DS}	80	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous (T _C =25°C)		75	А
Drain Current-Continuous (T _C =100°C)	− I _D	48	А
Drain Current-Pulsed ¹	I _{DM}	300	А
Single Pulse Avalanche Energy ²	Eas	125	mJ
Single Pulse Avalanche Current ²	I _{AS}	50	А
Power Dissipation (T _C =25°C)	В	98	W
Power Dissipation-Derate Above 25°C	− P _D	0.78	W/°C
Thermal Resistance, Junction-to-Ambient	R _{θJA}	62	°C/W
Thermal Resistance, Junction-to-Case	R _{eJC}	1.27	°C/W
Storage Temperature Range	T _{STG}	-55 To +150	°C
Operating Junction Temperature Range	TJ	-55 To +150	°C







Electrical Characteristics (T_J=25°C unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Off Characteristics		-1		•	•	•
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	80	-	-	V
Drain-Source Leakage Current	I _{DSS}	V_{DS} =80V , V_{GS} =0V, T_J =25°C	-	-	1	μA
Brain Godice Leakage Guitent		V_{DS} =64V , V_{GS} =0V, T_J =85°C	-	-	10	μΑ
Gate-Source Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics		•	-	-	-	-
Static Drain-Source On-	R _{DS(ON)}	V _{GS} =10V, I _D =10A	-	5.8	7	mΩ
Resistance	TUS(ON)	V _{GS} =4.5V, I _D =8A	-	8.6	11	mΩ
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	1.2	1.6	2.5	V
Forward Transconductance	g _{fs}	V_{DS} =10V, I_{D} =3A	-	9	-	S
Dynamic and Switching Characte	eristics					
Total Gate Charge ^{3,4}	Qg		-	31	45	nC
Gate-Source Charge ^{3,4}	Q_gs	V_{DS} =40V, I_{D} =30A, V_{GS} =10V	-	4	5.5	
Gate-Drain Charge ^{3,4}	Q_{gd}		-	9.5	15	
Turn-On Delay Time ^{3,4}	t _{d(on)}		-	22	33	nS
Rise Time ^{3,4}	t _r	$V_{DD}=40V,$ $R_{G}=6\Omega,$ $V_{GS}=10V,$ $I_{D}=30A$	-	16	24	
Turn-Off Delay Time ^{3,4}	$t_{\text{d(off)}} \\$		-	40	60	
Fall Time ^{3,4}	t _f		-	31	47	
Input Capacitance	C_{lss}	.,, .,	-	1720	2580	pF
Output Capacitance	C_{oss}	V _{DS} =40V, V _{GS} =0V, F=1MHz	-	350	525	
Reverse Transfer Capacitance	C_{rss}]	-	10.5	15	
Gate Resistance	R_g	V_{GS} =0V, V_{DS} =0V, F=1MHz	-	1.1	-	Ω
Drain-Source Diode Characterist	ics and Maxi	mum Ratings	-	-	-	•
Continuous Source Current	Is	$V_G=V_D=0V$,	-	-	75	А
Pulsed Source Current	I _{SM}	Force Current	-	-	150	Α
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =1A, T _J =25°C	-	-	1	V
Reverse Recovery Time	T _{rr}	V _R =50V, I _S =10A,	-	40	-	nS
Reverse Recovery Charge	Q _{rr}	− di/dt=100A/μs, T _J =25°C	-	55	-	nC

^{1.} Repetitive rating: Pulsed width limited by maximum junction temperature. 2. $V_{DD}\text{=}25V,\,V_{GS}\text{=}10V,\,L\text{=}0.1\text{mH},\,I_{AS}\text{=}50A,\,R_{G}\text{=}25\Omega,\,starting}\,T_{J}\text{=}25^{\circ}\text{C}.$

^{3.} Pulse test: pulse width≤300us, duty cycle ≤2%.
4. Essentially independent of operating temperature.



Typical Electrical and Thermal Characteristic Curves

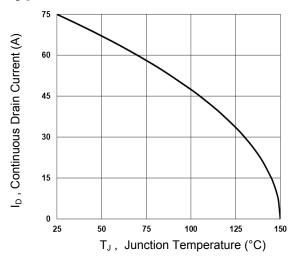


Fig.1 Continuous Drain Current vs. TJ

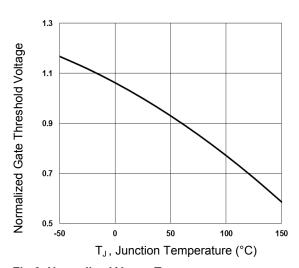


Fig.3 Normalized V_{th} vs. T_J

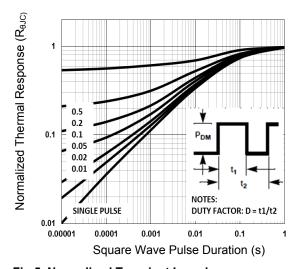


Fig.5 Normalized Transient Impedance

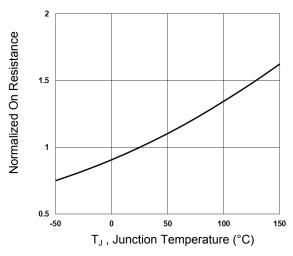


Fig.2 Normalized R_{DS(ON)} vs. T_J

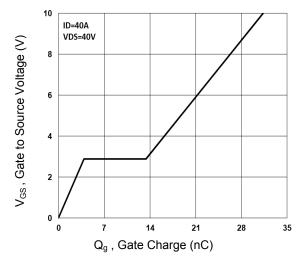


Fig.4 Gate Charge Characteristics

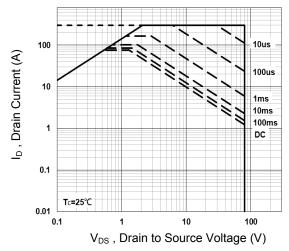
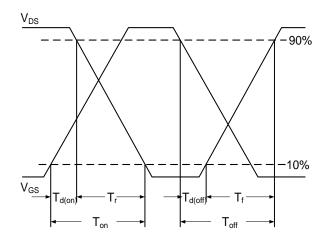


Fig.6 Maximum Safe Operation Area



Typical Electrical and Thermal Characteristic Curves



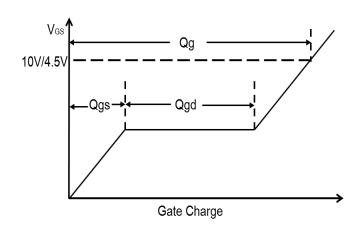


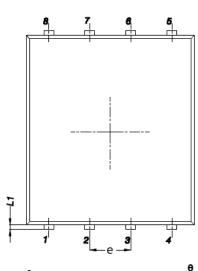
Fig.7 Switching Time Waveform

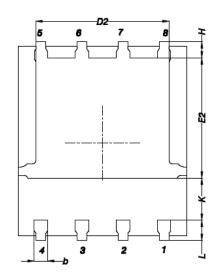
Fig.8 Gate Charge Waveform

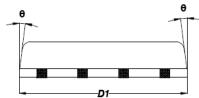


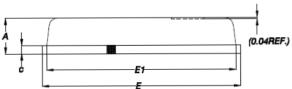
Package Outline Dimensions

PPAK5x6









Symbol	Dimensions In Millimeters		Dimensions In Inches		
	MAX	MIN	MAX	MIN	
А	1.200	0.850	0.047	0.031	
b	0.510	0.300	0.020	0.012	
С	0.300	0.200	0.012	0.008	
D1	5.400	4.800	0.212	0.189	
D2	4.310	3.610	0.170	0.142	
E	6.300	5.850	0.248	0.230	
E1	5.960	5.450	0.235	0.215	
E2	3.920	3.300	0.154	0.130	
е	1.27BSC		0.05BSC		
Н	0.650	0.380	0.026	0.015	
K		1.100		0.043	
L	0.710	0.380	0.028	0.015	
L1	0.250	0.050	0.009	0.002	
θ	12°	0°	12°	0°	